## tion For U.S. Patent Application

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name. I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled SELECTIVE REDUCTION TYPE HIGH TEMPERATURE SUPERCONDUCTOR AND METHODS OF MAKING THE SAME the specification of which is attached hereto unless the following is checked: was filed on March 17, 2000 as United States Application Number or PCT International X Application Number PCT/JP00/01669 and was amended on (if applicable). I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claim(s), as amended by any amendment referred to above. I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, § 1.56. I hereby claim foreign priority benefits under Title 35, United States Code, § 119 (a) - (d) of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed: Priority Claimed 1999-85003 (List prior Japan 26/03/1999 2 Yes ☐ No foreign (Number) (Country) (Day/Month/Year Filed) applications. ☐ Yes ☐ No See note A (Number) (Country) (Day/Month/Year Filed) on back of ☐ Yes ☐ No this page) (Number) (Country) (Day/Month/Year Filed) ☐ Yes ☐ No (Number) (Country) (Day/Month/Year Filed) (See note B on back of this page) See attached list for additional prior foreign applications I hereby claim the benefit under Title 35, United States Code, § 119(e) of any United States provisional application(s) listed below. (Application Number) (Filing Date) (Application Number) (Filing Date) I hereby claim the benefit under Title 35, United States Code, § 120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, § 112, I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, § 1.56 which became available between the filing date of the prior application and the national or PCT international filing date of the application: (Application Serial Number) (List Prior U.S. (Filing Date) (Status) (patented, pending, abandoned) Applications) (Application Serial Number) (Filing Date) (Status) (patented, pending, abandoned)

I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith:

James E. Armstrong, III, Reg. No. 18,366; William F. Westerman, Reg. No. 29,988; Ken-Ichi Hattori, Reg. No. 32,861; Le-Nhung McLeland, Reg. No. 31,541; Ronald F. Naughton, Reg. No. 24,616; John R. Pegan, Reg. No. 18,069; William G. Kratz, Jr., Reg. No. 22,631; Albert Tockman, Reg. No. 19,722; Mel R. Quintos, Reg. No. 31,898; Donald W. Hanson, Reg. No. 27,133; Stephen G. Adrian, Reg. No. 32,878; William L. Brooks, Reg. No. 34,129; John F. Carney, Reg. No. 20,276; Edward F. Welsh, Reg. No. 22,455; Patrick D. Muir, Reg. No. 37,403; Gay A. Spahn, Reg. No. 34,978; John P. Kong, Reg. No. 40,054; and Luke A. Kilyk, Reg. No. 33,251.

Please direct all communications to the following address:

ARMSTRONG, WEST LAMAN, HATTORI, McLELAND & NAUGHTON 1725 K Street, N.W., Suite 1000 Washington, D.C. 20006 Telephone: (202) 659-2930 Fax: (202) 887-0357

Hideo, IHARA

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Title 18 of the United States Code, § 1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

	Full name of sole or first inventor (given name, family name)	Hideo, In	IARA		
(See note C above)	Inventor's Signature / dideo Lhara	Date _	Aug. 10.	200/	
	Residence Ibaraki, Japan				
	Post Office Address 4-10-8, Matsushiro, Tsuk				an
	Post Office Address 4-10-0, Indebusin210, 15ak	454 5.11, 11	, da	3 0000	
Full name of	second inventor (given name, family name)				
Inventor's Sig	gnature	Date _			
Residence		Citizenship _			
Post Office A	Address				
Full name of	third inventor (given name, family name)		· · · · · · · · · · · · · · · · · · ·		
Inventor's Sig	gnature	Date _			
Residence		Citizenship _			
•	Address				
Full name of	fourth inventor (given name, family name)				
Inventor's Sig	gnature	Date _			
Residence		Citizenship _			
	Address		· · · · · · · · · · · · · · · · · · ·		
Full name of	fifth inventor (given name, family name)				
Inventor's Sig	gnature	Date _			
Post Office A	Address			·	
Full name of	sixth inventor (given name, family name)				
Inventor's Sig	gnature	Date _	2		
Residence		Citizenship _			
Post Office A	Address				
Full name of	seventh inventor (given name, family name)				
Inventor's Sig	gnature	Date _		9	
Residence		Citizenship _			
Post Office A	Address				
Full name of	f eighth inventor (given name, family name)				
	ignature				
Post Office A	Address				